

## 2SC0115T2A0-12 Preliminary Data Sheet

Dual-channel ultra-compact cost-effective SCALE™-2+ driver core

### Short Description

The cost-effective SCALE™-2+ dual-driver core 2SC0115T2A0-12 combines unrivalled compactness with broad applicability. The 2SC0115T2A0-12 dual channel gate-driver core is made for 90kW to 500kW inverters and converters. Leveraging SCALE-2+ integrated circuit and isolated transformer technology for DC/DC power and switching signal transmission, the driver core improves system reliability and performance by eliminating the need for an opto-coupler. The driver core's reinforced electrical isolation targets systems with a working voltage of 900V, which is typical for 1200V IGBT modules and complies with the PD2 and OV II clearance and creepage requirements of IEC 60664-1 and IEC 61800-5-1. The 2SC0115TA0-12 gate-driver core supports modules up to 1400A and switching frequencies of up to 50kHz.

With a footprint of 53.1mm x 31mm and a profile of just 13mm the 2SC0115TA0-12 gate-driver core is the most compact industrial unit of its type available. Compared with conventional drivers, the highly-integrated SCALE-2+ chipset uses about 85% fewer components than competing products. It includes short-circuit protection by  $V_{CEsat}$  monitoring and supply-voltage monitoring independently from the primary and secondary side. The new gate-driver core supports full Advanced Active Clamping (AAC) to control the IGBT voltage overshoot during turn-off.

Each of the two output channels is electrically isolated from the primary side and the other secondary channel. An output current of  $\pm 15A$  and 1.4W drive power is available per channel with a gate voltage swing of +15V to -6V. The turn-on voltage is regulated to maintain a stable 15V regardless of the output power level.

Its outstanding EMC allows safe and reliable operation even in harsh industrial applications.

### Product Highlights

- ✓ Ultra-compact dual-channel driver
- ✓ Highly integrated SCALE-2+ chipset
- ✓ Gate current  $\pm 15A$
- ✓ 1W @85°C output power per channel
- ✓ Advanced Active Clamping (AAC)
- ✓ +15V/-6V gate driving
- ✓ IGBT blocking voltages up to 1200V
- ✓ Reinforced insulation according to IEC 60664-1
- ✓ Short delay and low jitter
- ✓ Interface for 3.3V...15V logic level
- ✓ UL-compliant
- ✓ Lead-free

### Applications

- ✓ Industrial motor drives
- ✓ Premium drives
- ✓ Uninterruptible power supplies (UPS)
- ✓ PV converters
- ✓ Electric/hybrid drive vehicles
- ✓ Switched mode power supplies (SMPS)
- ✓ Medical equipment (MRT, CT, X-ray)
- ✓ Welding and plasma cutters
- ✓ Multilevel applications, 3-Level NPC1 and 2

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### Safety Notice!

The data contained in this data sheet is intended exclusively for technically trained staff. Handling all high-voltage equipment involves risk to life. Strict compliance with the respective safety regulations is mandatory!

Any handling of electronic devices is subject to the general specifications for protecting electrostatic-sensitive devices according to international standard IEC 60747-1, Chapter IX or European standard EN 100015 (i.e. the workplace, tools, etc. must comply with these standards). Otherwise, this product may be damaged.

### Important Product Documentation

This data sheet contains only product-specific data. For a detailed description, must-read application notes and important information that apply to this product, please refer to "2SC0115T Description & Application Manual" on [www.power.com/igbt-driver/go/2SC0115T](http://www.power.com/igbt-driver/go/2SC0115T).

### Absolute Maximum Ratings

Parameter	Remarks	Min	Max	Unit
Supply voltage $V_{CC}$	VCC to GND	0	16	V
Logic input and output voltages	Primary side, to GND	-0.5	$V_{CC}+0.5$	V
SO current	Failure condition, total current		20	mA
Logic input/output voltage $V_{SOAx}$	To COMx	-0.5	$V_{ISOx}+0.5$	V
SOAx current			20	mA
Gate peak current $I_{out}$	Note 1	-15	+15	A
External gate resistance	From GHx to GLx, switching frequency $\leq 25$ kHz	1		$\Omega$
	From GHx to GLx, switching frequency $> 25$ kHz	2.5		$\Omega$
	From GHx/GLx to IGBT gate	1.2		$\Omega$
Average supply current $I_{CC}$	Notes 2, 3		355	mA
Output power	Ambient temperature $\leq 55^{\circ}\text{C}$ (Notes 4, 18)		1.4	W
	Ambient temperature $\leq 70^{\circ}\text{C}$ (Notes 4, 5, 18)		1.2	W
	Ambient temperature $\leq 85^{\circ}\text{C}$ (Notes 4, 5, 18)		1.0	W
	Ambient temperature $\leq 105^{\circ}\text{C}$ (Notes 4, 5)		0.4	W
Test voltage (50Hz/1min.)	Primary to secondary (Note 15)		4000	$V_{AC(eff)}$
	Secondary to secondary (Note 15)		4000	$V_{AC(eff)}$
Switching frequency f			50	kHz
$ dV/dt $	Rate of change of input to output voltage		50	kV/ $\mu\text{s}$
Operating voltage	Primary/secondary, secondary/secondary		1200	$V_{peak}$
Operating temperature		-40	+105	$^{\circ}\text{C}$
Storage temperature		-40	+105	$^{\circ}\text{C}$

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### Recommended Operating Conditions

Power Supply	Remarks	Min	Typ	Max	Unit
Supply voltage $V_{CC}$	VCC to GND	14.5	15	15.5	V

### Electrical Characteristics

All data refer to +25°C and  $V_{CC} = 15V$  unless otherwise specified.

Power supply	Remarks	Min	Typ	Max	Unit
Supply current $I_{CC}$	Without load		40		mA
Coupling capacitance $C_{io}$	Primary side to secondary side, per channel		24		pF

Power Supply Monitoring	Remarks	Min	Typ	Max	Unit
Supply threshold $V_{CC}$	Primary side, clear fault	11.6	12.6	13.6	V
	Primary side, set fault (Note 12)	11.0	12.0	13.0	V
Monitoring hysteresis	Primary side, set/clear fault	0.35			V
Supply threshold $V_{ISOx}-V_{Ex}$	Secondary side, clear fault	11.8	12.6	13.4	V
	Secondary side, set fault (Note 13)	11.2	12.0	12.8	V
Monitoring hysteresis	Secondary side, set/clear fault	0.35			V
Supply threshold $V_{Ex}-V_{COMx}$	Secondary side, clear fault		5.15		V
	Secondary side, set fault (Note 13)		4.85		V
Monitoring hysteresis	Secondary side, set/clear fault		0.3		V

Logic Inputs and Outputs	Remarks	Min	Typ	Max	Unit
Input bias current	$V(INx) > 3V$		190		μA
Turn-on threshold	$V(INx)$		2.6		V
Turn-off threshold	$V(INx)$		1.3		V
SO output voltage	Failure condition, $I(SO) \leq 20mA$			0.7	V
SOAx output voltage	Failure condition, $I(SOAx) \leq 20mA$			0.7	V
External fault input $V_{SOAx}-V_{COM}$	Set external fault		1.0		V
	Clear external fault		2.70		V
Hold time	Set external fault ( $V_{SOAx} = \text{low}$ )	2			μs
Delay	Clear external fault ( $V_{SOAx} = \text{high}$ )		0.1		μs
Acknowledge pulse width $T_{(ack)}$			700		ns

Short-Circuit Protection	Remarks	Min	Typ	Max	Unit
Vce-monitoring threshold	Note 9		9.3		V
Minimum response time	Note 10		4.5		μs
Minimum blocking time	Note 11		9		μs

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Timing Characteristics	Remarks	Min	Typ	Max	Unit
Turn-on delay $t_{d(on)}$	Note 6		80		ns
Turn-off delay $t_{d(off)}$	Note 6		65		ns
Jitter of turn-on delay	Note 17		±2		ns
Jitter of turn-off delay	Note 17		±2		ns
Output rise time $t_{r(out)}$	Note 7		6		ns
Output fall time $t_{f(out)}$	Note 7		12		ns
Transmission delay of fault state	Note 14		450		ns
Electrical Isolation	Remarks	Min	Typ	Max	Unit
Test voltage (50Hz/1s)	Primary to secondary side (Note 15)		4000		$V_{eff}$
	Secondary to secondary side (Note 15)		4000		$V_{eff}$
Partial discharge extinction volt.	Primary to secondary side (Note 16)	1800			$V_{peak}$
	Secondary to secondary side (Note 16)	1440			$V_{peak}$
Creepage distance	Primary to secondary side	9			mm
	Secondary to secondary side	5.5			mm
Clearance distance	Primary to secondary side	9			mm
	Secondary to secondary side	5.5			mm
Outputs	Remarks	Min	Typ	Max	Unit
Blocking capacitance	VISOx to VEx (Note 8)		9.4		μF
	VEx to COMx (Note 8)		10		μF

### Output voltage swing

The output voltage swing consists of two distinct segments. First, there is the turn-on voltage  $V_{GHx}$  between pins GHx and VEx.  $V_{GHx}$  is regulated and maintained at a constant level for all output power values and frequencies.

The second segment of the output voltage swing is the turn-off voltage  $V_{GLx}$ .  $V_{GLx}$  is measured between pins GLx and VEx. It is a negative voltage. It changes with the output power to accommodate the inevitable voltage drop across the internal DC/DC converter.

Output Voltage	Remarks	Min	Typ	Max	Unit
Turn-on voltage, $V_{GHx}$	Any load condition		15.0		V
Turn-off voltage, $V_{GLx}$	No load		-8.5		V
	1W output power		-6.6		V
	1.2W output power		-6.3		V
	1.4W output power		-6.0		V

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### Footnotes to the Key Data

- 1 ) The maximum peak gate current refers to the highest current level occurring during the product lifetime. It is an absolute value and does also apply to short pulses.
- 2 ) The average supply input current is limited for thermal reasons. Higher values than those specified by the absolute maximum rating are permissible (e.g. during power supply start-up) if the average remains below the given value, provided the average is taken over a time period which is shorter than the thermal time constants of the driver in the application.
- 3 ) There is no means of actively controlling or limiting the input current in the driver. In the case of a short circuit at the output, the supply input current has to be limited externally.
- 4 ) The maximum output power must not be exceeded at any time during operation. The absolute maximum rating must also be observed for time periods shorter than the thermal time constants of the driver in the application.
- 5 ) Between 55°C and 70°C, 70°C and 85°C as well as between 85°C and 105°C the maximum output power can be linearly interpolated with the given values.
- 6 ) The delay time is measured between 50% of the input signal and a 10% voltage swing of the corresponding output. The delay time is independent of the output loading.
- 7 ) Output rise and fall times are measured between 10% and 90% of the nominal output swing. The values are given for the driver side of the gate resistors with turn-on and turn-off gate resistor values of 2.5Ω and without load. The time constant of the output load in conjunction with the present gate resistors leads to an additional delay at the load side of the gate resistors.
- 8 ) Refers to the values assembled on the driver core.
- 9 ) The Vce-monitoring threshold cannot be modified by the user.
- 10) The minimum response time is valid for the circuit given in the description and application manual with the values of the corresponding tables.
- 11) The blocking time sets a minimum time span between the end of any fault state and the start of normal operation (remove fault from pin SO). The value of the blocking time can be adjusted at pin TB. The specified blocking time is valid if TB is connected to GND.
- 12) Undervoltage monitoring of the primary-side supply voltage (VCC to GND). If the voltage drops below this limit, a fault is transmitted to the SO output and the IGBTs are switched off.
- 13) Undervoltage monitoring of the secondary-side supply voltage (VIS0x to VEx and VEx to COMx, which correspond to the approximate turn-on and turn-off gate-emitter voltages). If the corresponding voltage drops below this limit, the IGBT is switched off and a fault is transmitted to the SO output.
- 14) Transmission delay of the fault state from the secondary side to the primary status output.
- 15) HiPot testing (= dielectric testing) must generally be restricted to suitable components. Although this gate driver is suited to HiPot testing, it is strongly recommended to limit the testing time to 1s slots. Excessive HiPot testing at voltages much higher than 850V<sub>AC(eff)</sub> may lead to insulation degradation. No degradation has been observed over 1min. testing at 4000V<sub>AC(eff)</sub>. The transformer of every production sample shipped to customers has undergone 100% testing at the given value for 1s.
- 16) Partial discharge measurement is performed in accordance with IEC 60270 and isolation coordination specified in IEC 60664-1. The partial discharge extinction voltage between the primary and either secondary side is coordinated for reinforced isolation to IEC 60664-1.
- 17) Jitter measurements are performed with input signals INx switching between 0V and 5V referred to GND, with a corresponding rise time and fall time of 15ns.
- 18) If the switching frequency f is higher than 40kHz or the gate charge is greater than 8μC, then the maximum output power limit must be reduced by an additional amount of 100mW referred to the given values.

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### **RoHS Statement**

On the basis of Annexes II and III of European Directive 2011/65/EC of 08 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (RoHS), we hereby state that the products described in this datasheet do not contain lead (Pb), mercury (Hg), hexavalent chromium (Cr VI), cadmium (Cd), polibrometo of biphenyl (PBB) or polibrometo diphenyl ether (PBDE) in concentrations exceeding the restrictions set forth in Annex II of 2011/65/EC with due consideration of the applicable exemptions as listed in Annex III of 2011/65/EC.

### **Legal Disclaimer**

The statements, technical information and recommendations contained herein are believed to be accurate as of the date hereof. All parameters, numbers, values and other technical data included in the technical information were calculated and determined to our best knowledge in accordance with the relevant technical norms (if any). They may base on assumptions or operational conditions that do not necessarily apply in general. We exclude any representation or warranty, express or implied, in relation to the accuracy or completeness of the statements, technical information and recommendations contained herein. No responsibility is accepted for the accuracy or sufficiency of any of the statements, technical information, recommendations or opinions communicated and any liability for any direct, indirect or consequential loss or damage suffered by any person arising therefrom is expressly disclaimed.

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## Preliminary Data Sheet

### Ordering Information

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Type Designation	Description
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2SC0115T2A0-12	Dual-channel SCALE-2+ driver core
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Product home page: [www.power.com/igbt-driver/go/2SC0115T](http://www.power.com/igbt-driver/go/2SC0115T)

Refer to [www.power.com/igbt-driver/go/nomenclature](http://www.power.com/igbt-driver/go/nomenclature) for information on driver nomenclature.

### Information about Other Products

**For other drivers, product documentation, and application support:**

Please click: [www.power.com](http://www.power.com)

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